



倍顯(香港)有限公司
Facelcd(HongKong) Limited

Doc.No.:

REV : A

PAGE : 1/19

SPEC TITLE
DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

Specifications

TFT-LCDmodule

Model No: FB018DFS302-A

Customer name:

The project name:

For Customer's Acceptance	
Approved by	Comment

	Signature	Date
Prepared by		
Checked by		
Approved by		



Contents

1	General Description	3
1.1	Features	3
1.2	Application	3
2	Outline Dimension	4
3	Electrical Characteristics	5
3.1	TFT-LCD Module	5
3.2	Back-Light Unit.....	5
4	Block Diagram	6
5	TFT-LCM Interface Specification	7
6	Description of Interface'Signal.....	8
6.1	RGB Interface Timing Characteristics	8
6.2	DC Characteristics	8
6.3	AC Characteristics.....	9
6.4	Reset Characteristics	9
7	Optical Specification.....	10
8	Environment Absolute Maximum Ratings	13
9	Reliability Test Items	13
10	Inspection Standard.....	14
11	Package	15
12	Precautions	16
12.1	Handling	16
12.2	Storage.....	16
12.3	Operation	17
12.4	Touch Panel Mounting Notes	17
12.5	Others	18
13	Records of Version.....	19



SPEC TITLE

DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

1 General Description

FB018DFS302-A is a transmissive type a-Si TFT-LCD (amorphous silicon thin film transistor liquid crystal display) module, which is composed of a TFT-LCD panel, a driver circuit a backlight unit, The panel size is 1.77inch and thresolution is 128x160. High image quality a-Si TFT LCD module. Partial-screen display function is available. Sleep and Stand-by modes are available for power saving.

1.1 Features

No	Item	Specification	Remark
1	Display Mode	High Resolution & Wide View	
2	Screen Size	1.77inch (diagonal)	
3	Resolution	128XRGBX160	
4	Color Number	262K TFT	
5	Color Arrangement	RGB-stripe	
6	Driver IC	ST7735S	
7	Back Light	White LED*2	
8	Viewing Direction	12 O'clock	
9	Interface	SPI4W 1DATA	
10	Surface Treatment	UV Cut	
11	touch panel		

1.2 Application

- ◆ Mobile phone.
- ◆ Portable multimedia device.

2 Outline Dimension

The mechanical detail is shown in Fig. 1 and summarized in Table 1 below.

Parameter	Specifications	Unit
Outline dimensions	34.70(W) x46.7(H) x 2.4+/-0.1(D) (LCM,no include FPC)	mm
Active area	28.03(W) x35.04(H)	mm
Resolution	128(H)RGBx160(V) dots	-
Dot size	0.219x0.219	mm
Luminance value	220	cd/m ²



PAGE : 4/19

EFFECTIVE DATE : 2018-05-23





SPEC TITLE

DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

3 Electrical Characteristics

3.1 TFT-LCD Module

Item	Symbol	Unit	Condition	Min.	Typ.	Max.	Note
Power and Operation Voltage							
Analog Operating Voltage	VCI	V	Operating voltage	2.5	2.8	3.3	Note2
Logic Operating Voltage	VDDI	V	I/O supply voltage	1.65	2.8	3.3	Note2
Digital Operating voltage	VCORE	V	Digital supply voltage	-	1.5	-	Note2
Gate Driver High Voltage	VGH	V	-	12.0	-	21.0	Note3
Gate Driver Low Voltage	VGL	V	-	-12.5	-	-7.0	Note3
Driver Supply Voltage	-	V	[VGH-VGL]	-	-	32	Note3
Input and Output							
Logic High Level Input Voltage	VIH	V	-	0.7*VDDI	-	VDDI	Note1,2,3
Logic Low Level Input Voltage	VIL	V	-	VSS	-	0.3*VDDI	Note1,2,3
Logic High Level Output Voltage	VOH	V	IOL=-1.0mA	0.8*VDDI	-	VDDI	Note1,2,3
Logic Low Level Output Voltage	VOL	V	IOL=1.0mA	VSS	-	0.2*VDDI	Note1,2,3
Logic High Level Input Current	IIH	uA	-	-	-	1	Note1,2,3
Logic Low Level input Current	IIL	uA	-	-1	-	-	Note1,2,3
Logic Input Leakage Current	ILEA	uA	VIN=VDDI or VSS	-0.1	-	+0.1	Note1,2,3

Note 1: VDDI=1.65 to 3.3V, VCI=2.5 to 3.3V, AGND=VSS=0V, Ta=-30 to 70 (to +85 no damage) °C.

Note2: Please supply digital VDDI voltage equal or less than analog VCI voltage.

3.2 Back-Light Unit

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Current	IF	30	40	0	mA	IF=40mA IF=3.2V
Forward voltage	VF	2.9	3.2	3.5	V	
Chroma	X	0.250		0.30		
	Y	0.250		0.30		
Brightness	L	4000			Cd/m2	
Uniformity	UBL	80			%	

- 2 LEDs multiple circuit
- The luminous intensity of LED is strongly dependent on the driving current.
- It is recommended the input of backlight to be constant current rather than constant voltage.



SPEC TITLE

DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

5 TFT-LCM Interface Specification

Pin No	Symbol	Description	Note
1	NC	NC	
2	GND	Ground	
3	LED-K	Cathode pin OF backlight	
4	LED-A	Anode pin of backlight	
5	GND	Ground	
6	RESET	Reset signal input Pin	
7	D/C	This pin is used to be serial interface clock.	
8	SDA	The data is latched on the rising edge of the SCL signal.	
9	SCL	Second Data lane in 2 data lane serial interface.	
10,11	VCC	Power supply input for LCM:2.8V	
12	CS	Chip select input pin.	
13	GND	Ground	
14	NC	NC	



6 Description of Interface'Signal

6.1 RGB Interface Timing Characteristics

Table 24. (24/18/16-bit I/F, IOVCC = 1.65 to 3.30V, VCC = 2.60 to 3.30V)

Item	Symbol	Unit	Min	Typ	Max
VSYNC/HSYNC setup time	tSYNCS	ns	5	-	-
VSYNC/HSYNC hold time	tSYNCH	ns	5	-	-
DE setup time	tENS	ns	5	-	-
DE hold time	tENH	ns	5	-	-
PCLK "Low" level pulse width	PWDL	ns	10	-	-
PCLK "High" level pulse width	PWDH	ns	10	-	-
PCLK cycle time	tCYCD	ns	20	-	-
Data setup time	tPDS	ns	6	-	-
Date hold time	tPDH	ns	6	-	-
PCLK, VSYNC, HSYNC, DE rise/fall time	trgbr, trgbf	ns	-	-	13

6.2 DC Characteristics

Table 15. DC Characteristics

Item	Symbol	Unit	Test Condition	Min	Typ	Max	Notes
Input high voltage	V _{IH}	V	IOVCC = 1.65~3.3	0.8*IOVCC	-	IOVCC	
Input low voltage	V _{IL}	V	IOVCC = 1.65~3.3	-0.3	-	0.2*IOVCC	
Output high voltage (1) (DB17-0, SDO)	V _{OH1}	V	IOVCC = 1.65~3.3 IOH = 0.1mA	0.8*IOVCC	-	-	
Output low voltage (1) (DB17-0, SDO)	V _{OL1}	V	IOVCC = 1.65~3.3 IOL = 0.1mA	-	-	0.2*IOVCC	
I/O leakage current	I _{LI}	μA	Vin = 0~IOVCC	-1	-	1	
Current consumption during standby mode: (IOVCC - GND) + (VCC - GND)	I _{ST}	μA	IOVCC = VCC = VCI = 2.8V Ta = 25°C	-	1.4	10	



SPEC TITLE

DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

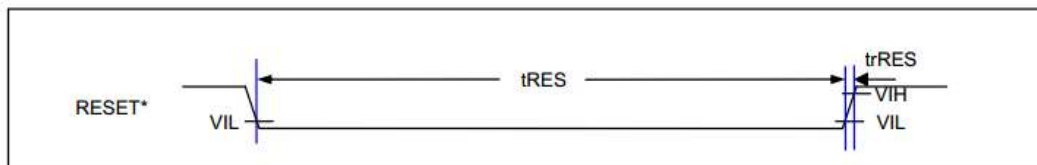
6.3 AC Characteristics

Item		Symbol	Unit	Min	Typ	Max
Serial clock cycle time	Write (received)	tSCYC	ns	20	-	-
	Read (transmitted)			100	-	-
Serial clock "High" level pulse width	Write (received)	tSCH	ns	10	-	-
	Read (transmitted)			50	-	-
Serial clock "Low" level pulse width	Write (received)	tSCL	ns	10	-	-
	Read (transmitted)			50	-	-
Serial clock rise/fall time		tscr, tscf	ns	-	-	20
Chip select setup time		tCSU	ns	20	-	-
Chip select hold time		tCH	ns	10	-	-
Serial input data setup time		tSISU	ns	5	-	-
Serial input data hold time		tSIH	ns	10	-	-
Serial output data setup time		tSOD	ns	80	-	150
Serial output data hold time		tSOH	ns	-	-	80

6.4 Reset Characteristics

Table 23. (Condition: IOVCC = 1.65 to 3.30V, VCC = 2.60 to 3.30V)

Item	Symbol	Unit	Min	Typ	Max
Reset "Low" level width	tRES	ms	1	-	-
Reset rise time	trRES	μs	-	-	10





SPEC TITLE

DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

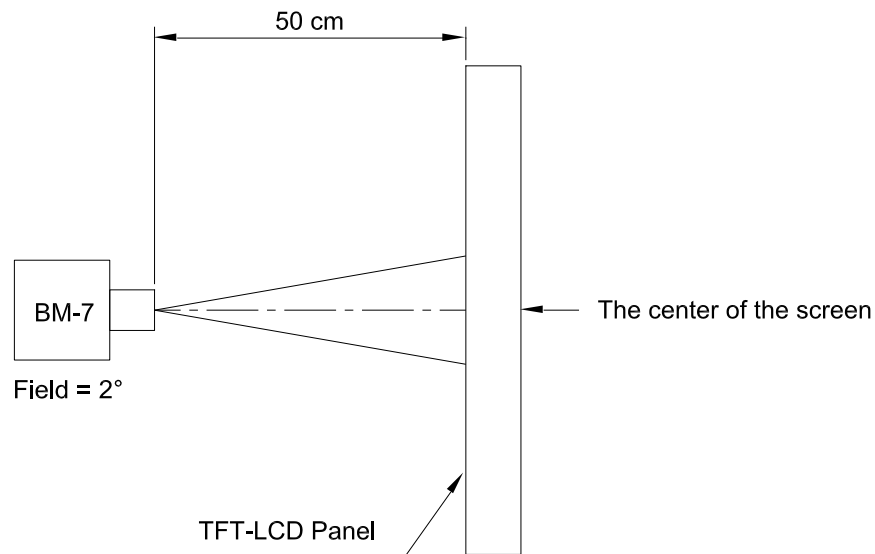
7. Optical Specification

C. Optical specifications							
Item	Symbol	Condition	Specification			Unit	Remark
			Min.	Typ.	Max.		
Response time (By Quick)	Tr+Tf	$\theta = 0^\circ$	-	30		ms	Note 5
Contrast ratio	CR	$\theta = 0^\circ$	-	250	-		Note 2,6
Viewing angle	Top	$CR \geq 10$	-	45	-	deg.	Note 2,6,7
	Bottom	$CR \geq 10$	-	20	-		
	Left	$CR \geq 10$	-	45	-		
	Right	$CR \geq 10$	-	45	-		
Color chromaticity (CF only with ITO, light source is C light, CIE 1931)	Wx	$\theta = 0^\circ$	-0.02	0.308	+0.02		Note 3
	Wy			0.325			
	Rx			0.612			
	Ry			0.329			
	Gx			0.299			
	Gy			0.567			
	Bx			0.144			
	By			0.110			
NTSC			-	55	-	%	Note 3
Cross talk	Ct		-	2	-	%	Note 9
Transmittance	Trans		-	5	-	%	Note 4



Note 1: The brightness test equipment setup

$I_B=60\text{mA}$, Field= 2° (As measuring “black” image, field= 2° is the best testing condition.)



Note 2: Definition of contrast ratio (C.R)

$$\text{C.R} = \frac{\text{Brightness When LCD is at "White" State}}{\text{Brightness When LCD is at "Black" State}}$$

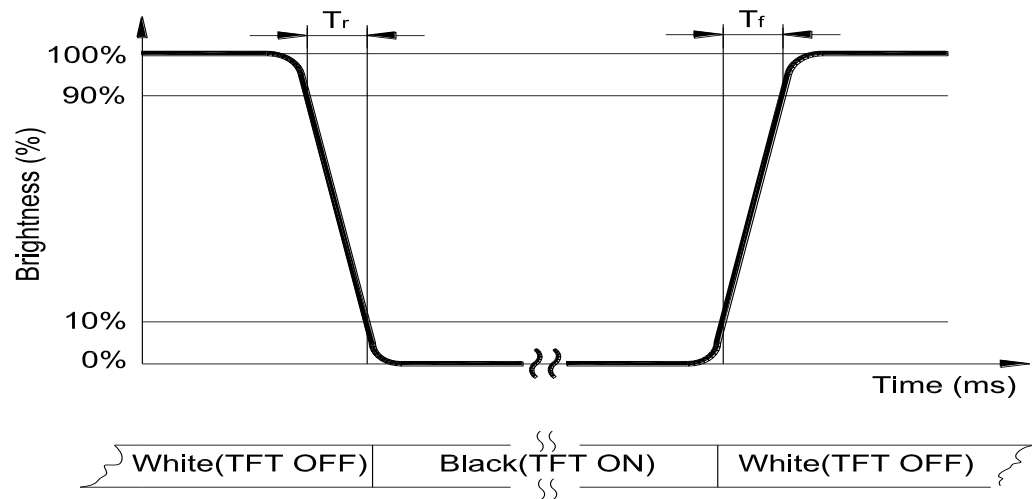
Note 3: Definition of response

time



SPEC TITLE
DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23



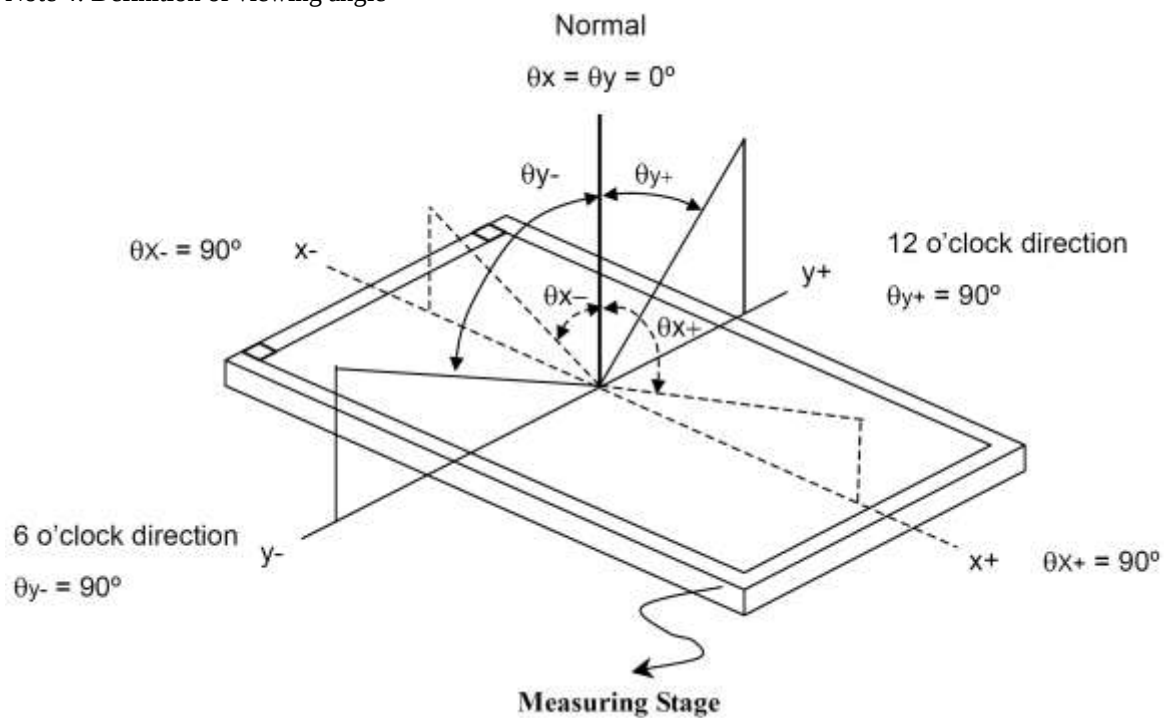


SPEC TITLE

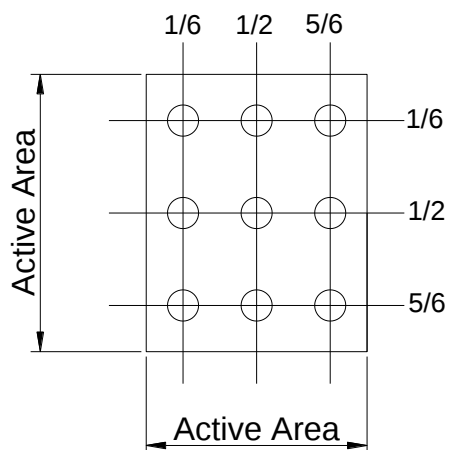
DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

Note 4: Definition of viewing angle



Note 5: Definition of uniformity (**Un**)



$$U_n = \frac{B_{\min}}{B_{\max}} \times 100\%$$



SPEC TITLE

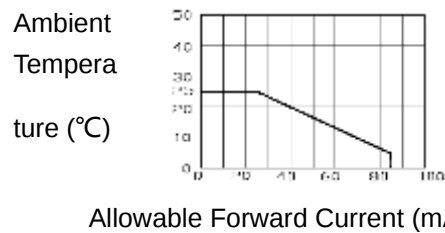
DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

8 Environment Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Remark
Operation temperature range	Top	-10	60	°C	Ambient
Storage temperature range	Tst	-20	70	°C	Ambient

- Corrosive gas environment is not acceptable.
- TFT-LCD color will change slightly depending on environment temperature. This phenomenon is reversible. Current reduction rate of LED backlight is according to the graph indicated below:



9 Reliability Test Items

Item	Test Condition		Criterion
High Temperature Storage	70 °C, 240 hrs		There should be no change which might affect the practical display function when the display quality test is conducted under normal operating condition.
Low Temperature Storage	-20 °C, 240 hrs		
High Temp. & High Humidity Storage	60 °C, 85% RH, 240 hrs		
Vibration Test (Non-operating)	Freq.:10~55~10 Hz, Amp.:1.5mm 1 hr for each direction of X, Y, Z		
Electrostatic Discharge Test (Non-operating)	Terminals	150 pF, 0 Ω, ±300 V, Contact	
	Panel	150 pF, 330 Ω, ±8 KV, Air	
Thermal Shock (Static)	-30°C, 30 min /80°C, 30 min, 20 cycles		
High Temperature Operation	60 °C, 240 hrs		
Low temperature Operation	-10 °C, 240 hrs		
High Temperature & High Humidity (Operating)	50 °C, 90% RH, 240 hrs		
FPC Peeling Strength Test	Pull speed: 50 mm/min, +90°,		> 400gf/cm

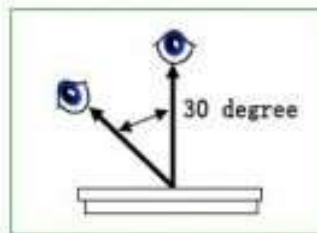


10 Inspection Standard

This standard apply to TFT module specification.

1. Inspection condition;

Under daylight lamp 20~40W, product distance inspector'eye 30cm.incline degree 30° .

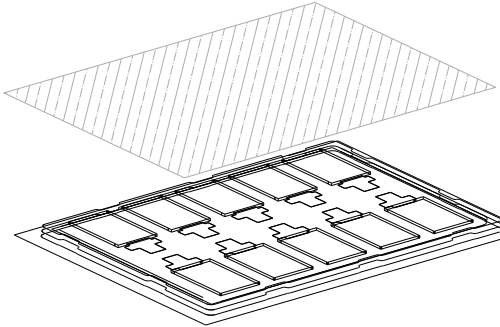
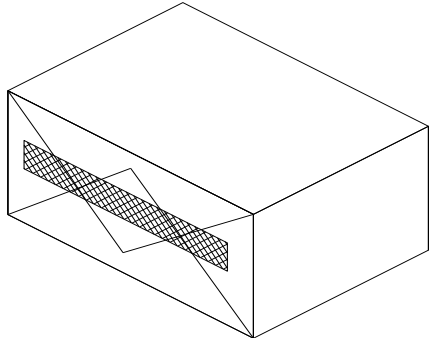
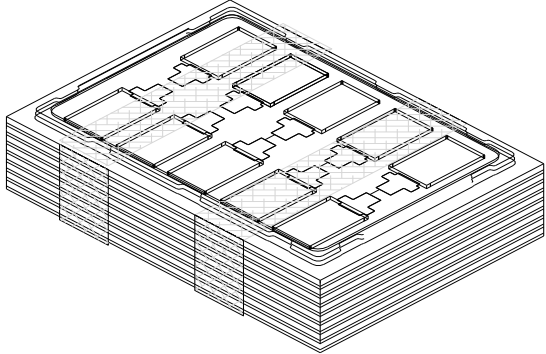
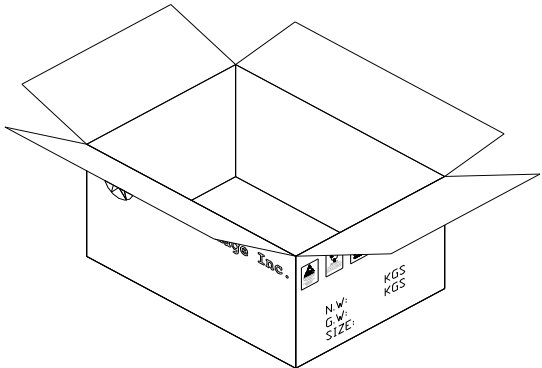
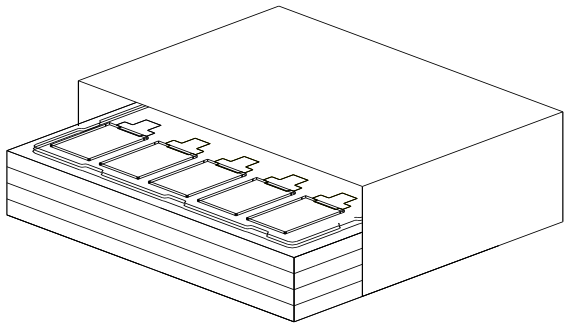
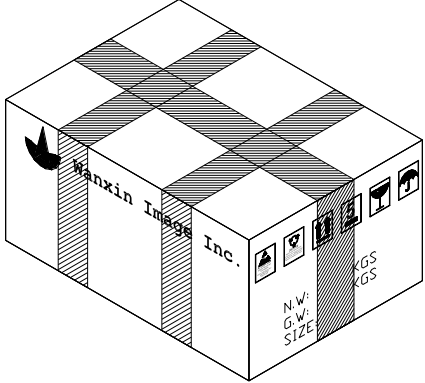


2. Inspection standard

NO.	Item	Inspection standard	Rate															
2.1	Dot	Case of Dot defect is below ① Bright Dot (whit spot) : "0" ② Dark Dot (black spot) : "0" (In case of Dark Dot on Main TFT LCD) - NG if there's full Dot defect. - Damaged less than the size of sub-pixel is not counted as defect - Dots darker than the size of sub-pixel are not defined as bright dot defect <table><tr><th>area size (mm)</th><th>Acceptable number</th></tr><tr><td>$\Phi \leq 0.10$</td><td>ignore</td></tr><tr><td>$0.10 < \Phi \leq 0.15$</td><td>3</td></tr><tr><td>$0.15 < \Phi \leq 0.20$</td><td>2</td></tr><tr><td>$0.25 < \Phi \leq 0.25$</td><td>1</td></tr><tr><td>$0.25 < \Phi$</td><td>0</td></tr></table>	area size (mm)	Acceptable number	$\Phi \leq 0.10$	ignore	$0.10 < \Phi \leq 0.15$	3	$0.15 < \Phi \leq 0.20$	2	$0.25 < \Phi \leq 0.25$	1	$0.25 < \Phi$	0	minor			
area size (mm)	Acceptable number																	
$\Phi \leq 0.10$	ignore																	
$0.10 < \Phi \leq 0.15$	3																	
$0.15 < \Phi \leq 0.20$	2																	
$0.25 < \Phi \leq 0.25$	1																	
$0.25 < \Phi$	0																	
2.2	line	<table><tr><th colspan="2">Size (mm)</th><th>Acceptable number</th></tr><tr><td>ignore</td><td>$W \leq 0.03$</td><td>ignore</td></tr><tr><td>$L \leq 4.0$</td><td>$0.03 < W \leq 0.04$</td><td>2</td></tr><tr><td>$L \leq 4.0$</td><td>$0.04 < W \leq 0.05$</td><td>1</td></tr><tr><td></td><td>$0.05 < W$</td><td>Treat with dot non-conformance</td></tr></table>	Size (mm)		Acceptable number	ignore	$W \leq 0.03$	ignore	$L \leq 4.0$	$0.03 < W \leq 0.04$	2	$L \leq 4.0$	$0.04 < W \leq 0.05$	1		$0.05 < W$	Treat with dot non-conformance	
Size (mm)		Acceptable number																
ignore	$W \leq 0.03$	ignore																
$L \leq 4.0$	$0.03 < W \leq 0.04$	2																
$L \leq 4.0$	$0.04 < W \leq 0.05$	1																
	$0.05 < W$	Treat with dot non-conformance																



11 Package

1		4	
10 pcs per tray + 1 cover (EPE)		Packing bag	
2		5	
15 trays + 1 dummy tray = 150 ps		Putting bag into carton Protected by 2 pieces of cushion EPE sheet	
3		6	
Putting trays into anti-electrostatic bag		Packing carton with sealing tape	



Carton outline size: 400×295×145 (mm)

12 Precautions

Please pay attentions to the followings as using the LCD module.

12.1 Handling

- (a) Do not apply strong mechanical stress like drop, shock or any force to LCD module. It may cause improper operation, even damage.
- (b) Because the polarizer is very fragile and easy to be damaged, do not hit, press or rub the display surface with hard materials.
- (c) Do not put heavy or hard material on the display surface, and do not stack LCD modules.
- (d) If the display surface is dirty, please wipe the surface softly with cotton swab or clean cloth.
- (e) Avoid using Ketone type materials (e.g. Acetone), Toluene, Ethyl acid or Methyl chloride to clean the display surface. It might damage the touch panel surface permanently. The recommended solvents are water and Isopropyl alcohol.
- (f) Wipe off water droplets or oil immediately.
- (g) Protect the LCD module from ESD. It will damage the LSI and the electronic circuit.
- (h) Do not touch the output pins directly with bare hands.
- (i) Do not disassemble the LCD module.
- (j) Do not lift the FPC of Touch Panel.

12.2 Storage

- (a) Do not leave the LCD modules in high temperature, especially in high humidity for a long time.
- (b) Do not expose the LCD modules to sunlight directly.
- (c) The liquid crystal is deteriorated by ultraviolet. Do not leave it in strong



SPEC TITLE

DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

ultraviolet ray for a long time.

- (d) Avoid condensation of water. It may cause improper operation.
- (e) Please stack only up to the number stated on carton box for storage and transportation. Excessive weight will cause deformation and damage of carton box.

12.3Operation

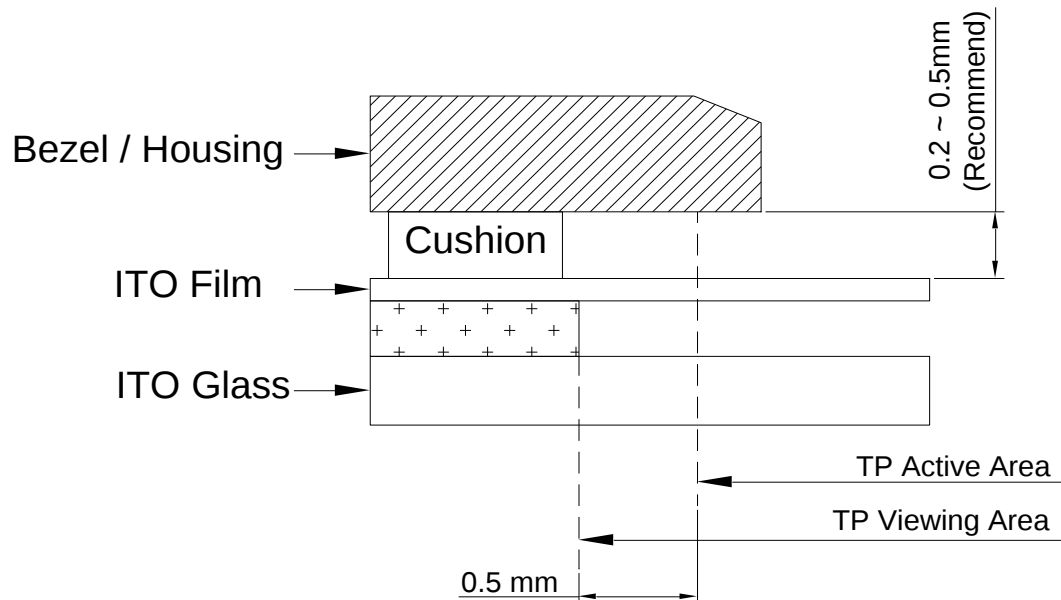
- (a) When mounting or dismounting the LCD modules, turn the power off.
- (b) Protect the LCD modules from electric shock.
- (c) The Driver IC control algorithms stated above should always obeyed to avoid damaging the LSI and electronic circuit.
- (d) Be careful to avoid mixing up the polarity of power supply for backlight.
- (e) Absolute maximum rating specified above has to be always kept in any case. Exceeding it may cause non-recoverable damage of electronic components or, nevertheless, burning.
- (f) When a static image is displayed for a long time, remnant image is likely to occur.
- (g) Be sure to avoid bending the FPC to an acute shape, it might break FPC.
- (h) Most of the touch screens have air vent to equalize the inside air pressure to the outside one. The air vent must be open and liquid contact must be avoided as the liquid may be absorbed if the liquid is accumulated near the air vent.
- (i) For the fragility of ITO film, it should avoid to use too tapering pen as the input material.

12.4Touch Panel Mounting Notes

- (a) If a cushion is used between bezel/housing and film must be choose as free as enough to absorb the expansion and contraction to avoid the distortion of film.
- (b) The cushion must be placed out of the Viewing Area.
- (c) Bezel/Housing edge must be posited between Key Area and Viewing Area. The edge enters the Key Area may cause unexpected input if the gap is too narrow or foreign particles like dusts exist between Bezel/Housing and ITO film.



(d) Mounting example:



The corner part has conductivity. Do not touch any metal part after mounting.

12.5Others

- If the liquid crystal leaks from the panel, it should be kept away from the eyes or mouth.
- For the fragility of polarizer, it is recommended to attach a transparent protective plate over the display surface.
- It is recommended to peel off the protection film on the polarizer slowly so that the electrostatic charge can be minimized.



倍顯(香港)有限公司
Facelcd(HongKong) Limited

Doc.No.:

REV : A

PAGE : 19/19

SPEC TITLE
DOCUMENT CONTROL SPECIFICATION

EFFECTIVE DATE : 2018-05-23

13 Records of Version

[illegible]